

# PRELIMINARY RESULTS OF PASSIVE-CMOS GUARD RING TEST STRUCTURES FROM THE MPW3 SUBMISSION

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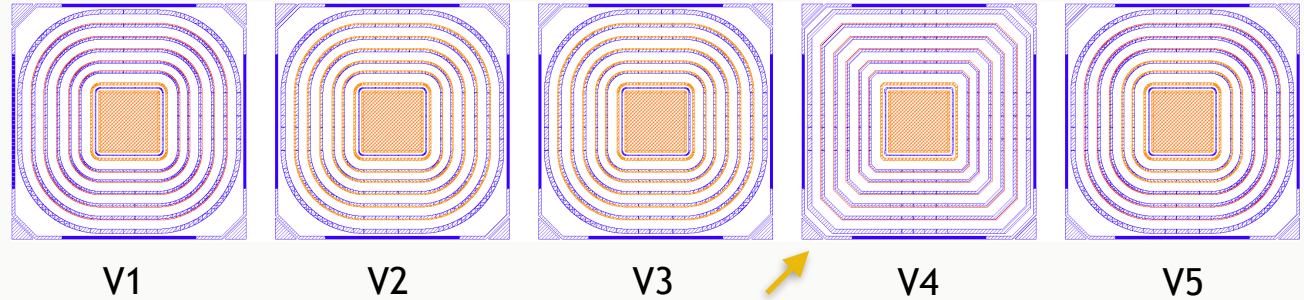
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# RECAP: THE TEST STRUCTURES

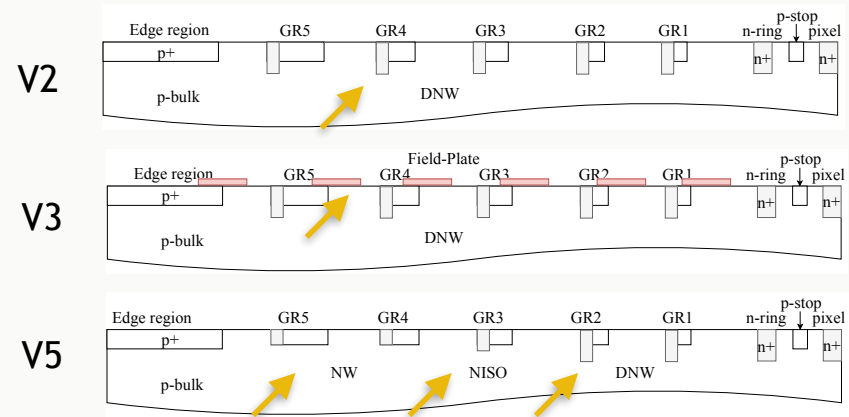
## – Geometry

- Pad (Pixel) + guard rings
- Substrate resistivity:  
1.9 kOhm & 3 kOhm
- Thickness: 280 um



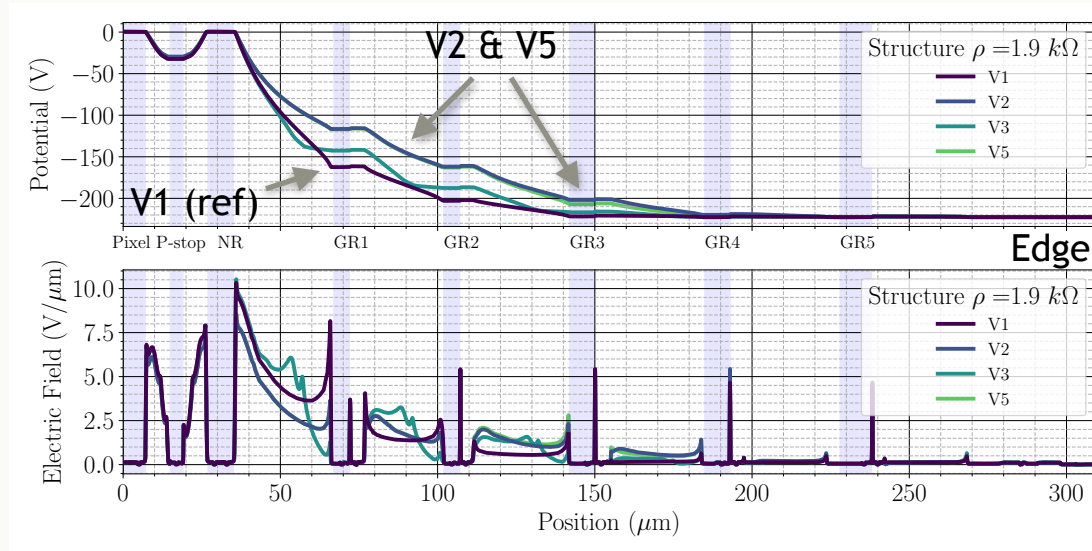
## – Guard ring types:

- V1 old design: n+p GR, large spacing between n-ring and GR1
- V2 based on V1: deep n-well replaces standard n-well at GR
- V3 based on V2: large overhang
- V4 based on V1: with chamfer corner
- V5 based on V1 & V2: with reducing n-well depth from inner to outer GR



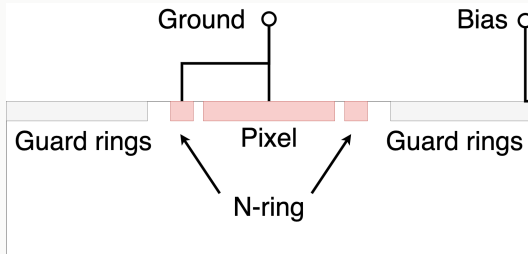
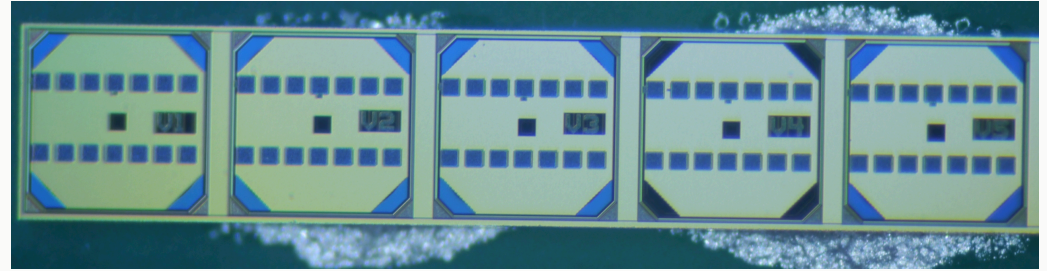
# BREAKDOWN SIMULATION

- Deduce from the potential distribution @ -200V:
  - Breakdown likely **between N-ring and GR1**, due to **large potential drop** (i.e. high E-field)
  - DNW suppresses this effect by **elevating the potential**
- ➔ **Visible increase of breakdown voltage after using DNW** :  $V2 > V1$  (ref)
- ➔ **Overhang can suppress the potential at GR**, meaning a higher E-field:  $V2 > V3 (\approx V1)$
- ➔ **Most critical location is between GR1 and N-ring**, **DNW in the inner GR** can already reduce the field:  $V5 \approx V2 > V3 (\approx V1)$
- ➔ **Chamfer GR corners should have higher field & according to the breakdown simulation:**  
 $V5 \approx V2 > V3 \approx V1 > V4$



# BREAKDOWN MEASUREMENT

- Measurement ambient:
  - T ~ 20 C
  - RH ~ 50%
  
- IV measurements
  - Ground the pixel and the n-ring
  - Frontside bias





# BREAKDOWN VOLTAGES

Reminder: expect  $V5 \approx V2 > V3 \approx V1 > V4$

- 4 samples, 2 per resistivity
- Structures exhibit 2-stage current increase
  - Especially for the high resistivity substrate

- Stage 1 near full depletion may relate to the unprocessed backside

[https://cleanroom.byu.edu/pn\\_junction](https://cleanroom.byu.edu/pn_junction) <https://www.pvlighthouse.com.au/resistivity>

full depletion voltage:

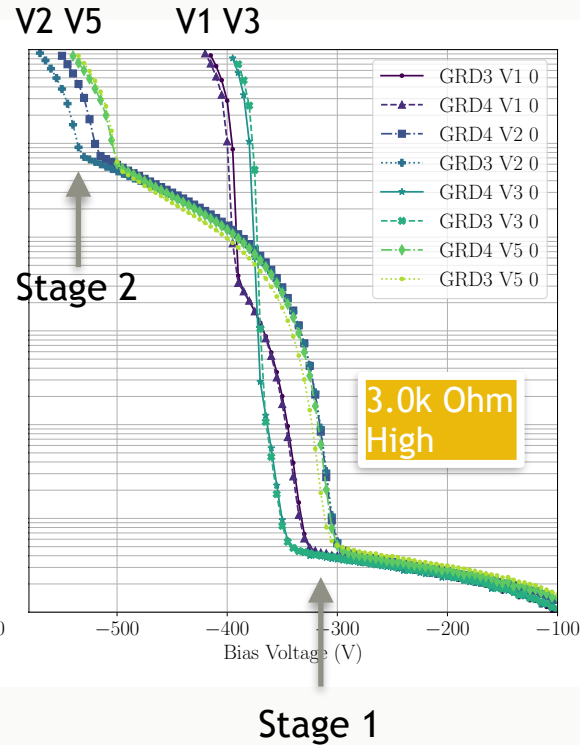
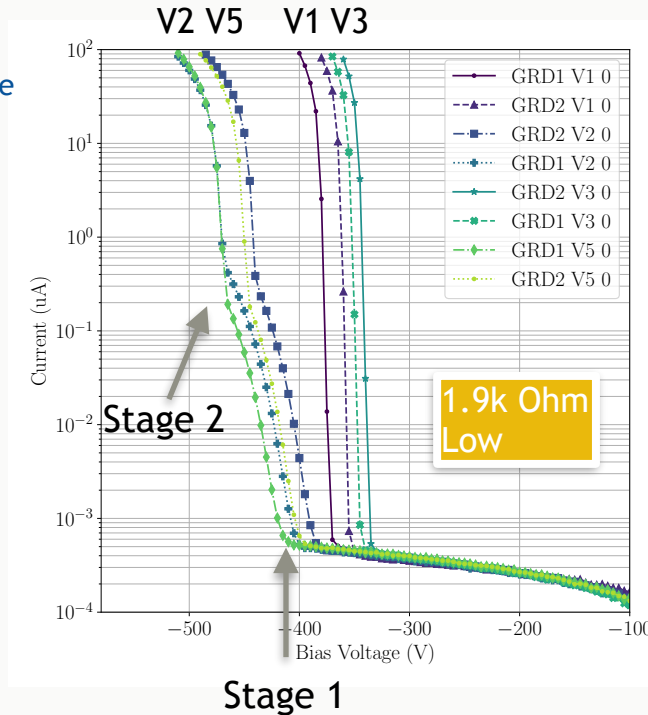
- 1.9k Ohm @ ~ -400V bias
- 3 kOhm @ ~ -320V bias

Similar effects see:

<http://dx.doi.org/10.1088/1748-0221/12/06/P06020>

- Stage 2 may be the real junction breakdown
  - Revealed the expectation

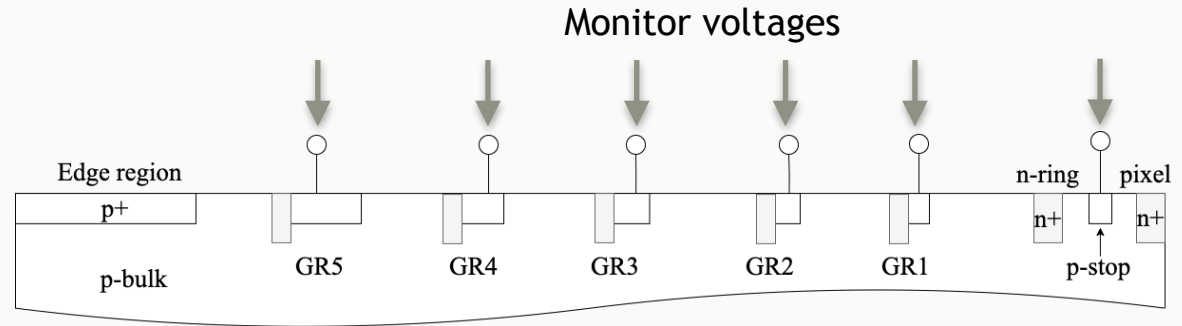
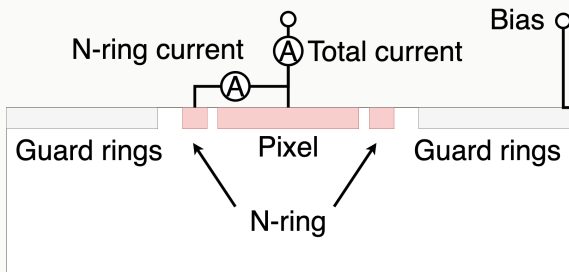
- Structure V4 has a breakdown smaller than 300 V



# CURRENT THROUGH N-RING & VOLTAGE PROBING

- 4 new samples, 2 per resistivity
- Wire-bond all the guard ring implants
- IV measurements
  - Ground pixel and n-ring
  - Frontside bias
  - Monitor total current and n-ring current simultaneously

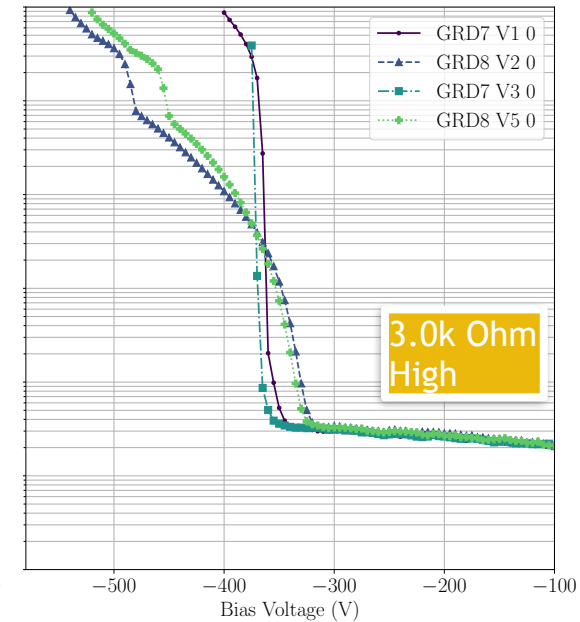
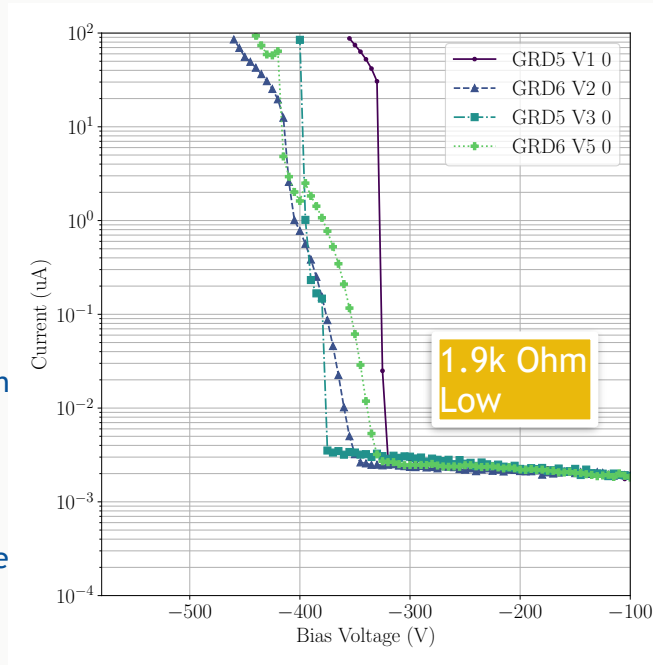
- Voltage probing
  - Ramp the bias voltage to -200 V
  - Monitor a p-implant for each bias ramp



# IV-CURVES OF FULLY BONDED SAMPLES

Compare with previous samples

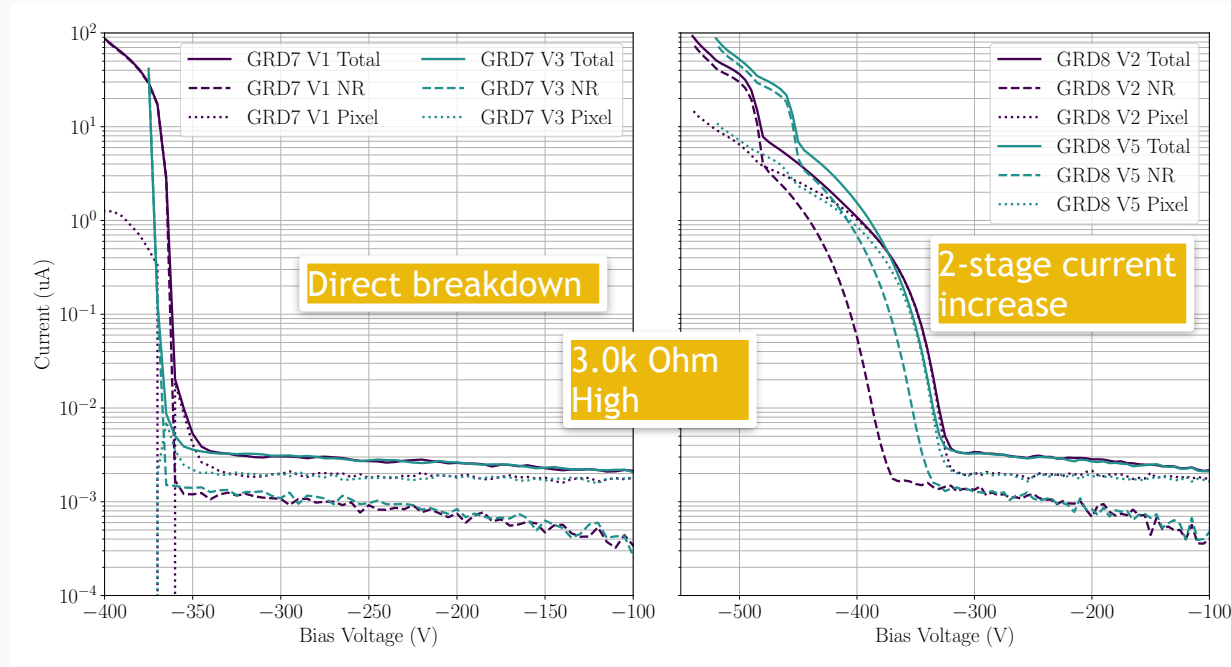
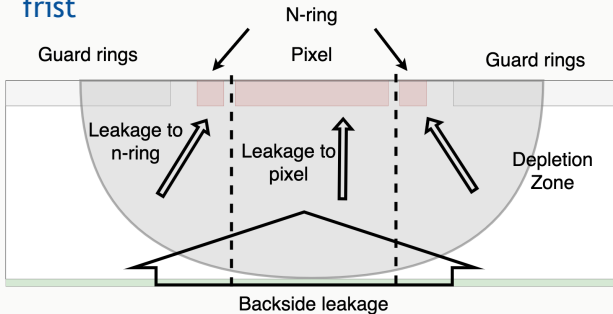
- Smaller breakdown voltages
- **Similar characteristics:**
  - Relation between structures in terms of breakdown voltage
  - 2-stage current increase
  - 1st current increase near the full depletion
- Until now, the uncertainty of the breakdown voltage is roughly within 50V
- But the behaviour looks very similar for all the measured samples



# THE 2-STAGE CURRENT INCREASE

- Total current, n-ring current, and pixel current
- Direct breakdown (V1, V3):
  - N-ring dominates the total current
  - > high current from the guard ring region
- 2-stage current increase (V2, V5):
  - Pixel current dominates the 1st step
  - The 2nd step mainly from guard rings

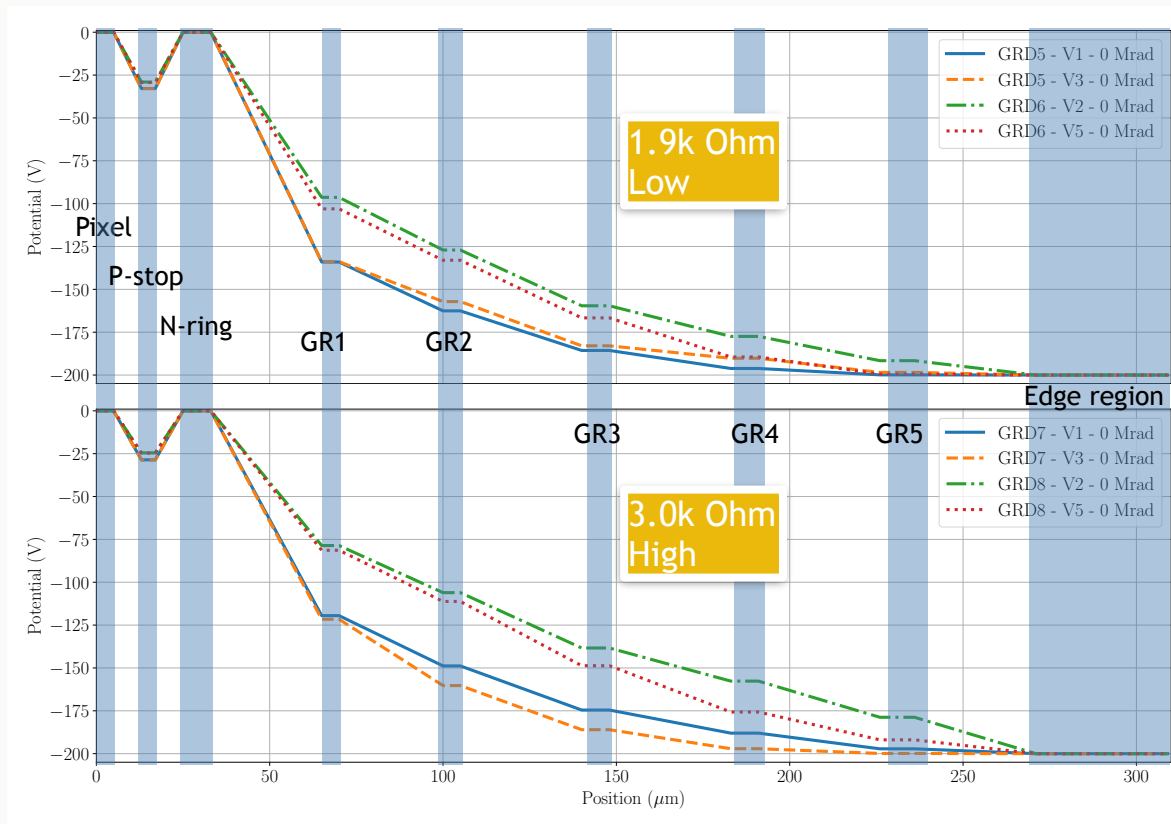
- conjecture:  
depletion region under pixel touches backside frist



# POTENTIAL DISTRIBUTION OF GUARD RINGS

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- Potential decreases from the N-ring to the edge ✓
  - Largest potential drop between N-ring and GR1 ✓
  - Effect of deep n-well:
    - Elevate the overall potential ✓ (comp. V1 & V2)
  - Effect of overhang:
    - Suppresses the potential ✓ (comp. V2 & V3)
    - Effect is stronger than simulations (comp. V1 & V3)
  - Reducing n-well depth:
    - Lift the inner rings ✓ (comp. V2 & V5)
- ➔ Visible increase of breakdown voltage using deep n-well (no overhang)



# SUMMARY

- Expect a visible increase of breakdown voltage after modifying guard ring structure with DNW
- Breakdown Measurements:
  - Current increases in 2 stages: backside leakage + real junction breakdown
  - Expected relation is validated:

$$V5 \approx V2 > V3 \approx V1 > 300 \text{ V} > V4$$

↑  
DNW +  
gradient

↑  
Full  
DNW

↑  
Full DNW  
+ overhang

↑  
ref

- Voltage probing:
  - DNW delivers a more smooth potential distribution, as predicted by simulations



# SIMULATION: BREAKDOWN IV

